

Part Number : <u>387206309</u> Product Description : 9.53mm Pitch Beau PCB Terminal Strip, without Mounting Ends, 9 Circuits Series Number : 38720 Status : Active Product Category : Terminal Blocks and Barrier Strip Engineering Number : 72509-C



Documents & Resources

Drawings Drawing 387206309_sd.pdf

3D Models and Design Files

3D Model 387206309_stp.zip

Specifications

Product Specification PS-38710-001-001.pdf

Product Environment Compliance

Compliance

GADSL/IMDS	Not Relevant
China RoHS	ø
EU ELV	Not Relevant
Low-Halogen Status	Low-Halogen per IEC 61249-2-21
REACH SVHC	Contains Lead monoxide per D(2023)3788-DC (14 Jun 2023)
EU RoHS	Compliant per EU 2015/863

Multiple Part Product Compliance Statements

- Eu RoHS
- REACH SVHC
- Low-Halogen

Multiple Part Industry Compliance Documents

- IPC 1752A Class C
- IPC 1752A Class D
- Molex Product Compliance Declaration
- IEC-62474
- chemSHERPA (xml)

EU RoHS Certificate of Compliance

Part Details

General

Status	Active
Category	Terminal Blocks and Barrier Strip
Series	38720
Description	9.53mm Pitch Beau PCB Terminal Strip, without Mounting Ends, 9 Circuits
Application	N/A
Component Type	One Piece
Product Family	Beau Barrier Strips
Product Name	Fixed Mount Barrier
Туре	Barrier Strip
UPC	800756334400

Electrical

Current - Maximum per Contact	15.0A
Voltage - Maximum	300V

Physical

Circuits (Loaded)	9
Circuits (maximum)	9
Color - Resin	Black
Entry Angle	Horizontal
Lock to Mating Part	None
Material - Metal	Brass
Material - Plating Mating	Tin
Material - Plating Termination	Tin
Material - Resin	Polyester

Net Weight	26.640/g
Number of Rows	1
Orientation	Horizontal
Panel Mount	No
PC Tail Length	4.80mm
PCB Retention	None
PCB Thickness - Recommended	3.18mm
Pitch - Mating Interface	9.53mm
Pitch - Termination Interface	9.53mm
Plating min - Mating	3.810µm
Plating min - Termination	3.810µm
Polarized to Mating Part	No
Shrouded	Dual-Barrier
Stackable	No
Temperature Range - Operating	-40° to +130°C
Wire Size (AWG)	14, 16, 18, 20, 22
Wire Size mm ²	0.50-1.50

Solder Process Data

Lead-Free Process Capability

WAVE

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